



US00D923607S

(12) **United States Design Patent** (10) **Patent No.:** **US D923,607 S**
Hosoda (45) **Date of Patent:** **** Jun. 29, 2021**

(54) **EARPHONES**

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(73) Assignee: **Wilx, Inc.**, Tokyo (JP)

(**) Term: **15 Years**

(21) Appl. No.: **29/660,611**

(22) Filed: **Aug. 22, 2018**

Related U.S. Application Data

(62) Division of application No. 35/503,472, filed on Feb. 6, 2017 (U.S. filing date under 35 U.S.C. 384), and having an international filing date of Feb. 6, 2017, now Pat. No. Des. 840,975.

(30) **Foreign Application Priority Data**

Dec. 5, 2016 (CN) 201630592607.3

(51) **LOC (13) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**

USPC D14/205, 206, 223; D29/112
CPC H04R 1/1066; H04R 1/1016; H04R 25/00;
H04R 1/10; H04R 5/0335; H04R 5/033
See application file for complete search history.

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(Continued)

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Much Shelist, P.C.

(57) **CLAIM**

The ornamental design for earphones, as shown and described.

DESCRIPTION

FIG. 1 is a rear right perspective view showing the new design for earphones;

FIG. 2 is a front elevation view thereof;

FIG. 3 is a rear elevation view thereof;

FIG. 4 is a top plan view thereof;

FIG. 5 is a bottom plan view thereof;

FIG. 6 is a right side view thereof;

FIG. 7 is a left side view thereof;

FIG. 8 is a rear top perspective view of the earpiece portion thereof at a larger scale;

FIG. 9 is a right top perspective view of the earpiece portion thereof at a larger scale;

FIG. 10 is a left bottom perspective view of the earpiece portion thereof at a larger scale;

FIG. 11 is a front perspective view of the earpiece portion thereof at a larger scale;

FIG. 12 is a front elevation view of the earpiece portion thereof at a larger scale;

FIG. 13 is a rear elevation view of the earpiece portion thereof at a larger scale;

FIG. 14 is a top plan view of the earpiece portion thereof at a larger scale;

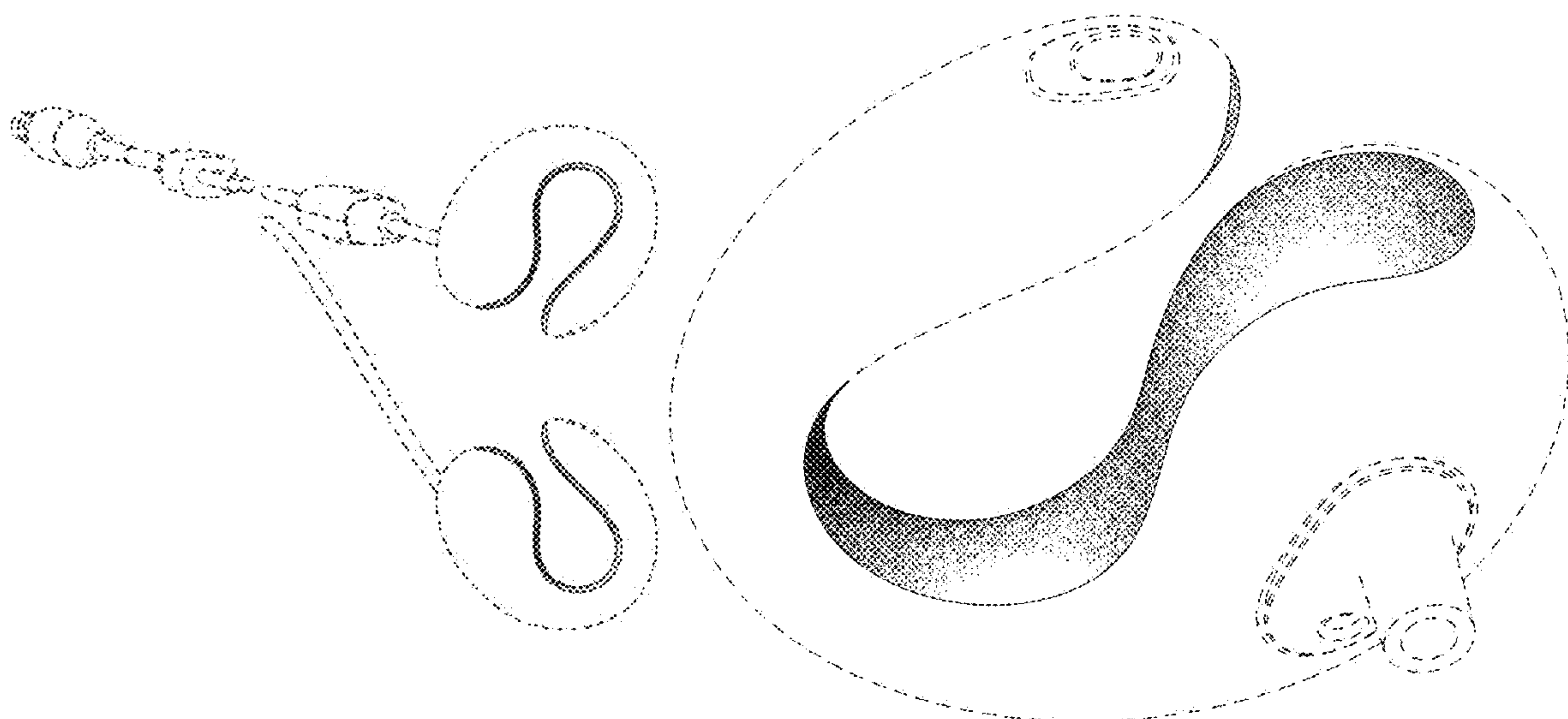
FIG. 15 is a bottom plan view of the earpiece portion thereof at a larger scale;

FIG. 16 is a right side view of the earpiece portion thereof at a larger scale; and,

FIG. 17 is a left side view of the earpiece portion thereof at a larger scale.

The broken lines in the FIGS. form no part of the claimed design.

1 Claim, 17 Drawing Sheets



(56)

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FIG. 1

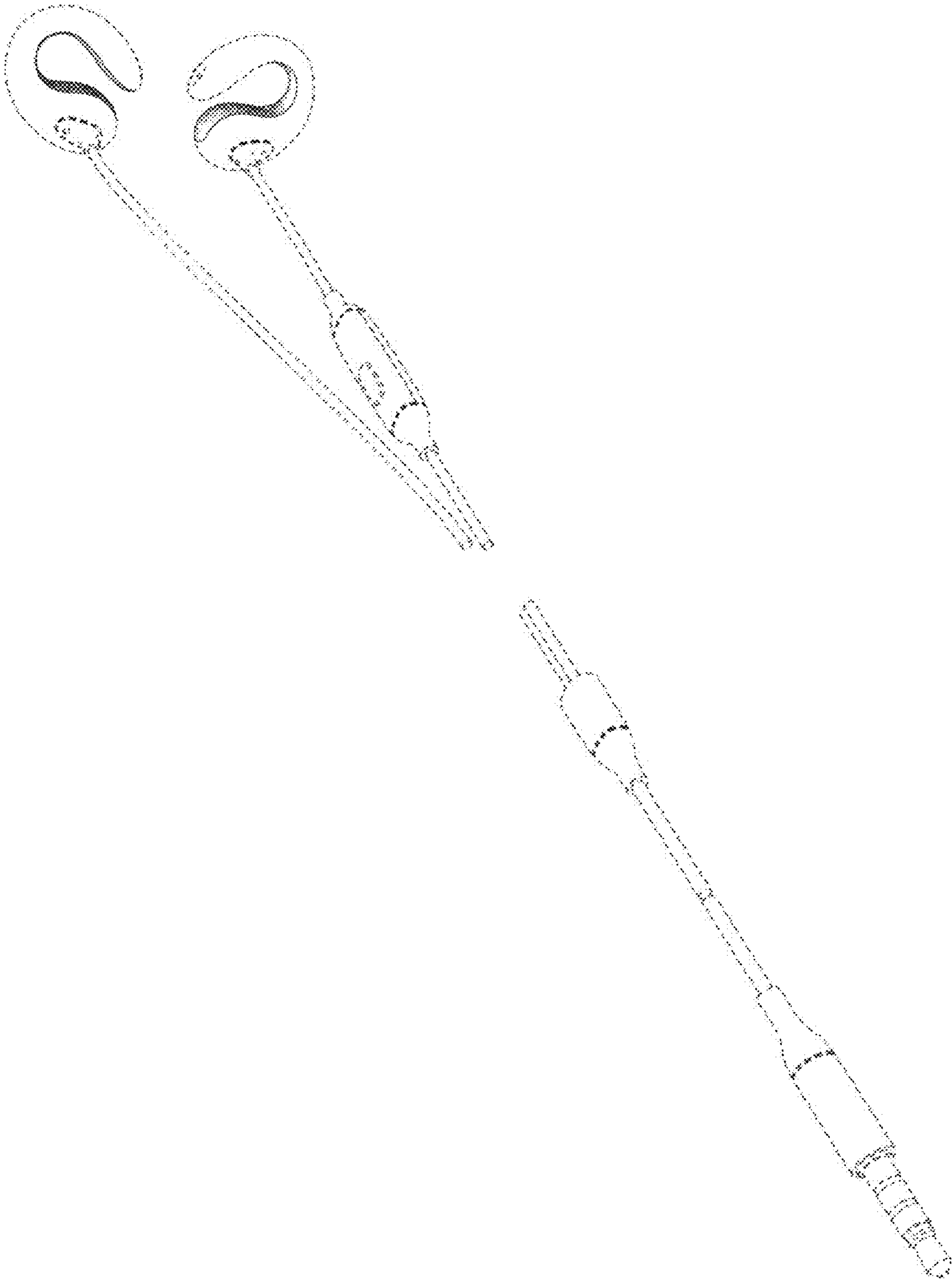


FIG. 2

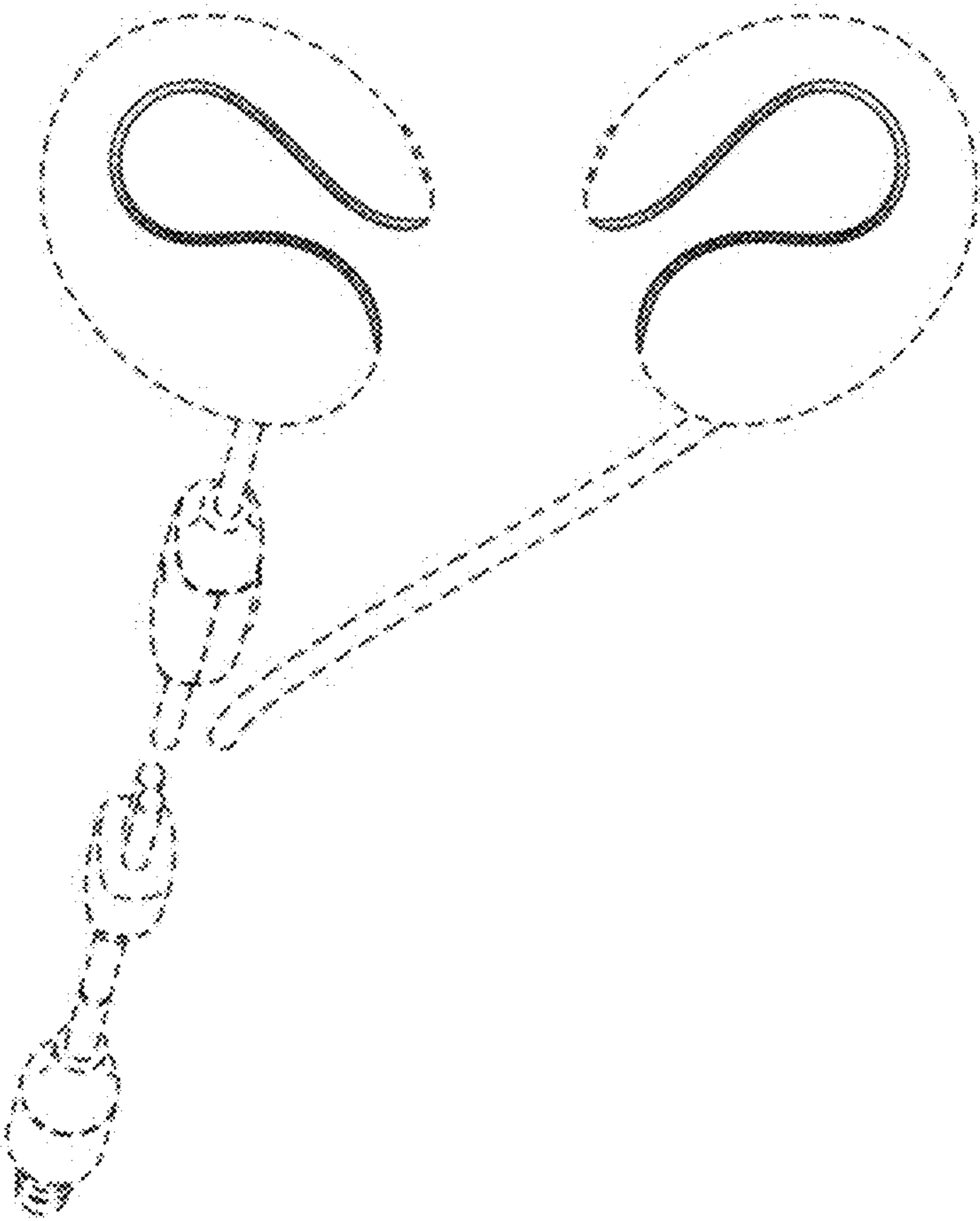


FIG. 3

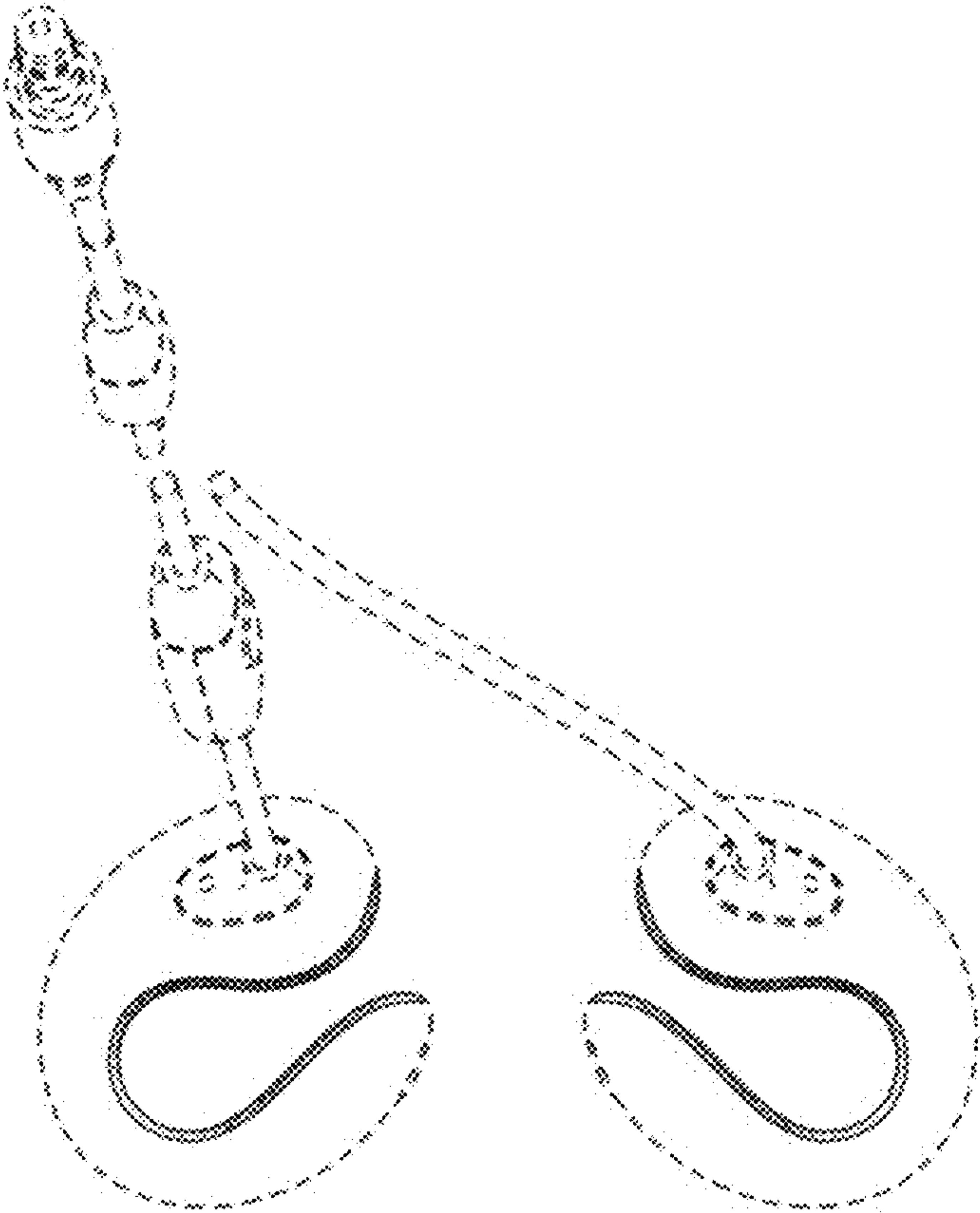


FIG.4

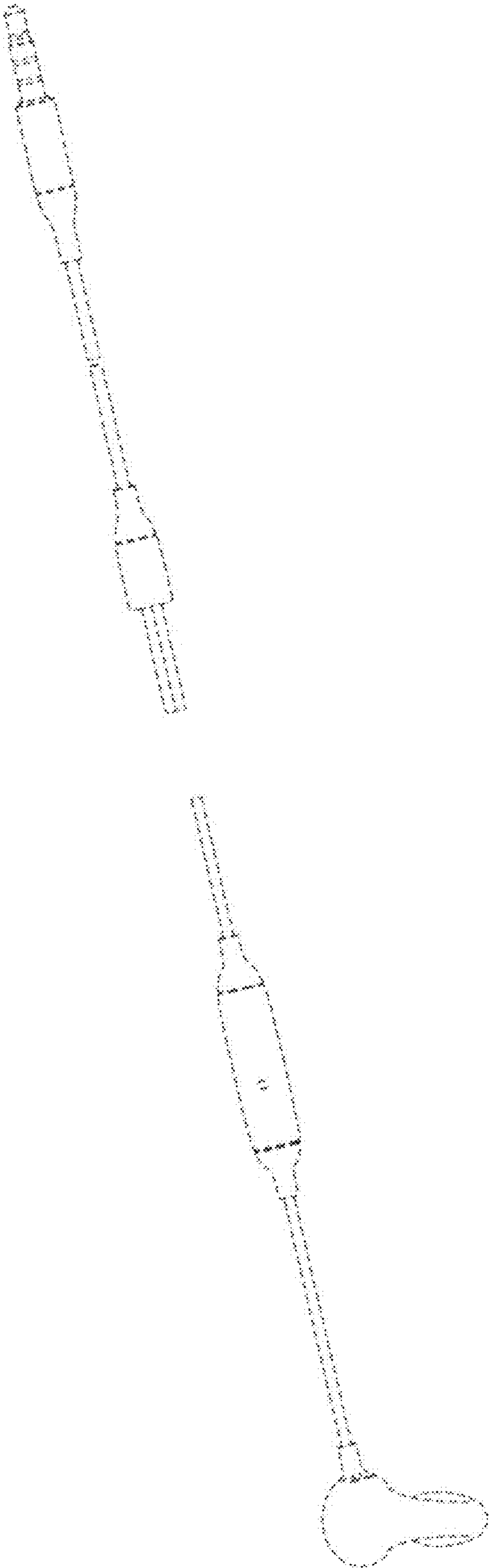


FIG. 5

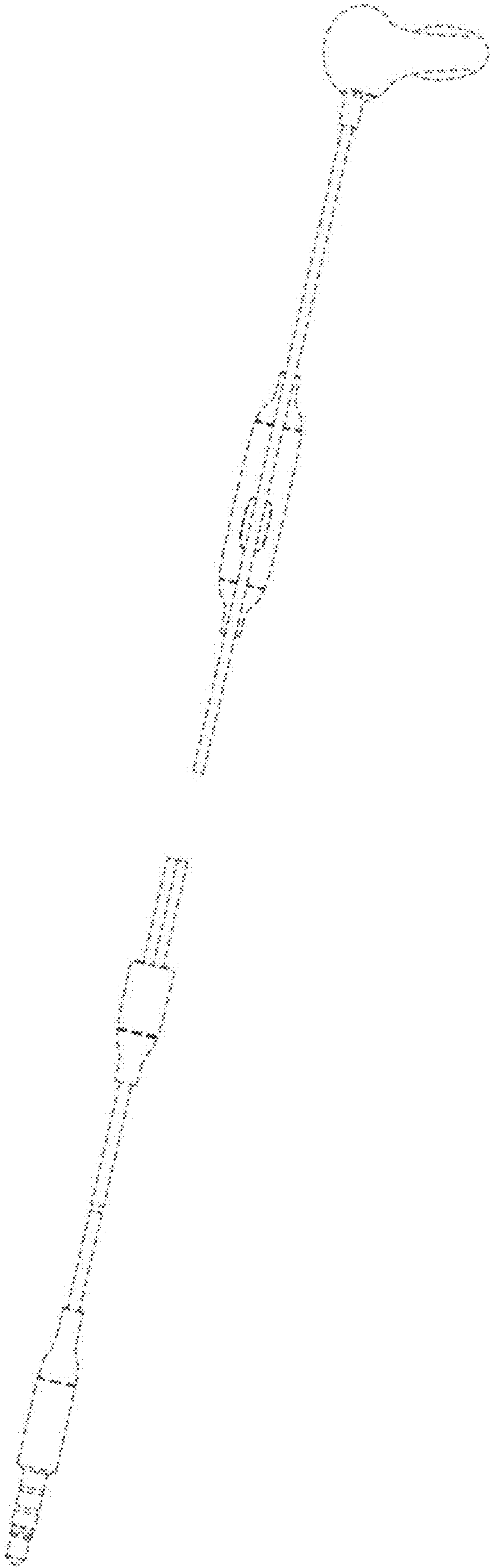


FIG. 6

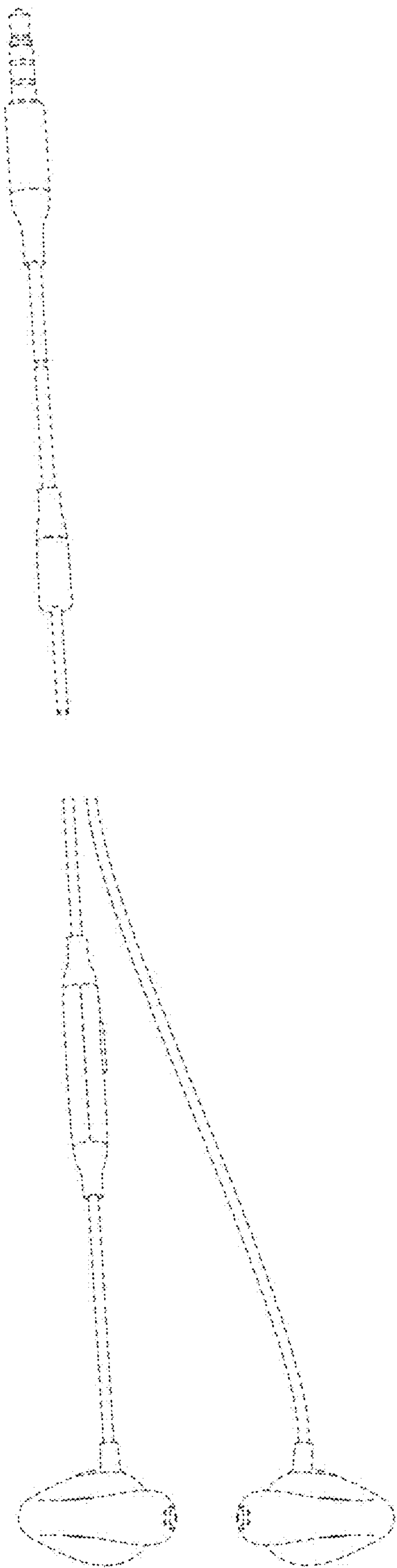


FIG. 7

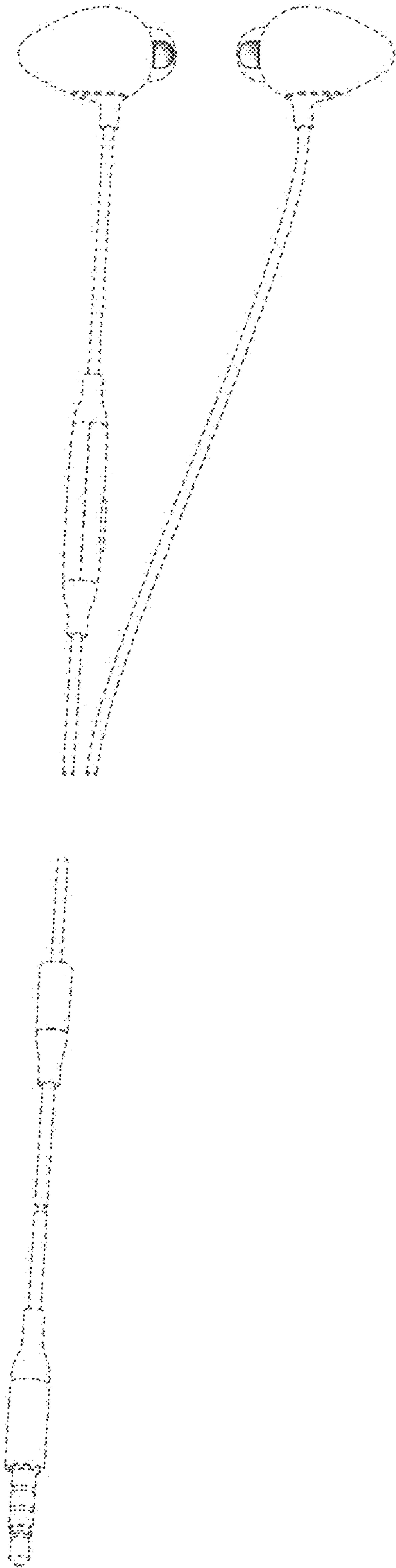


FIG. 8

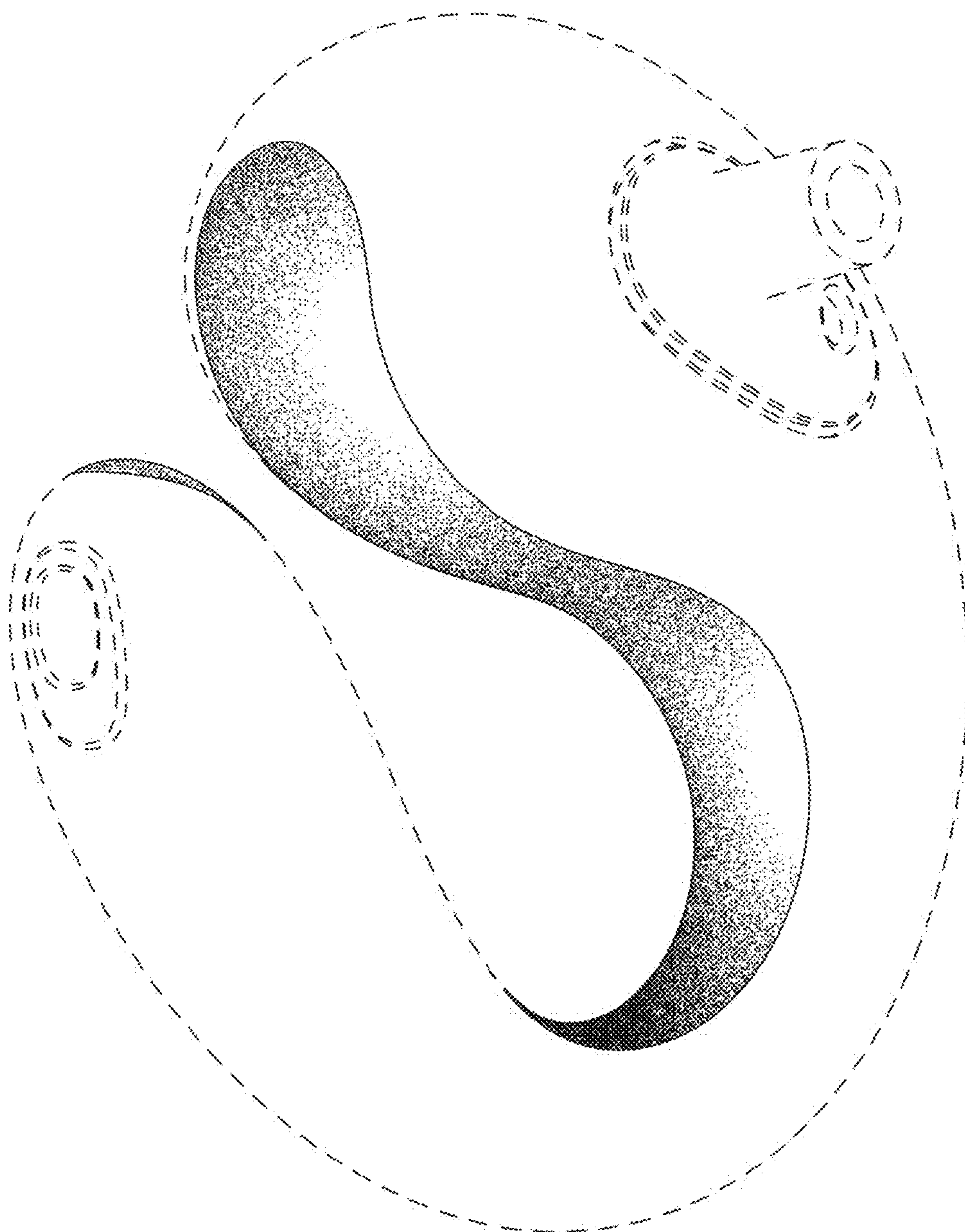


FIG. 9

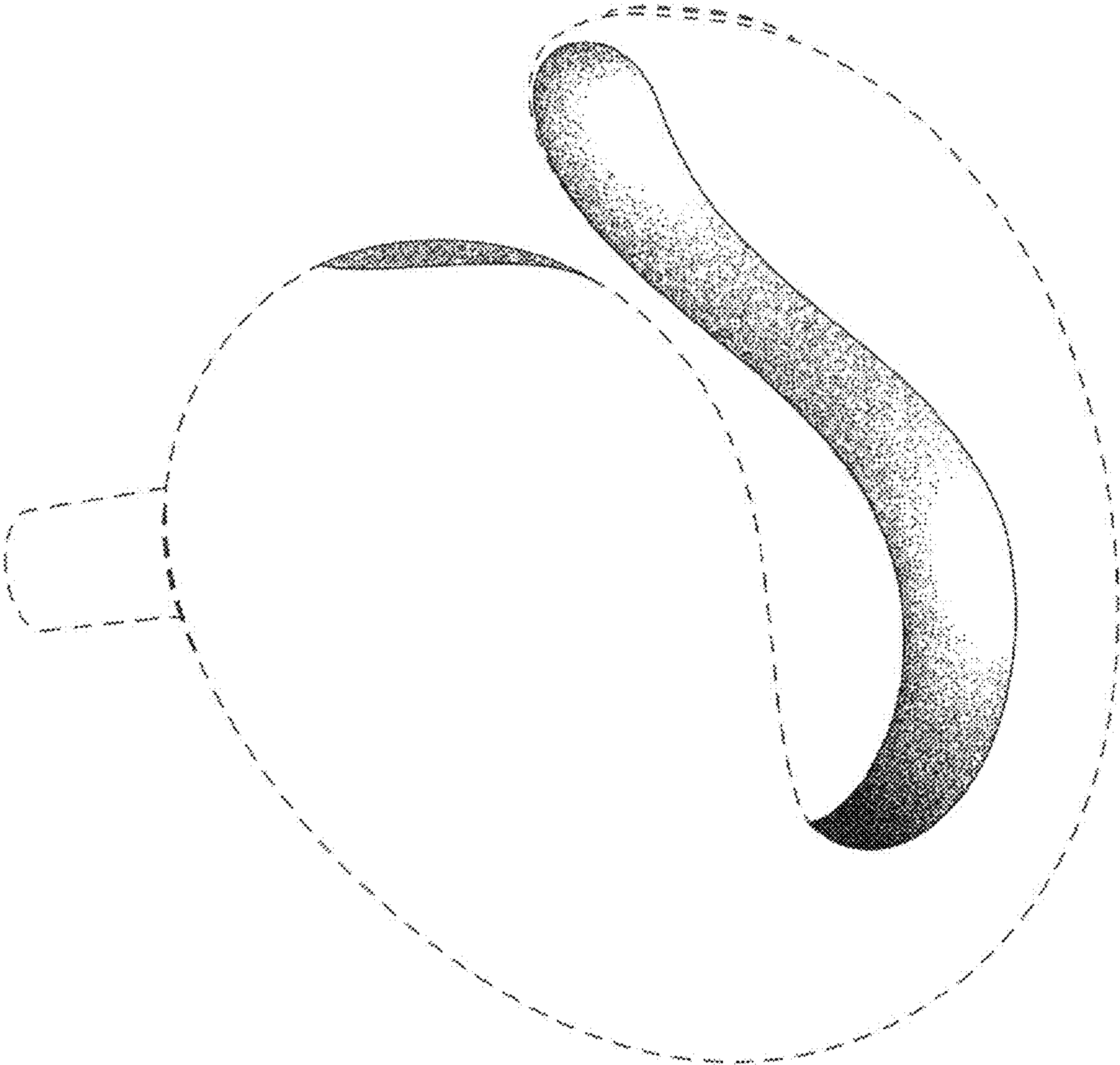


FIG. 10

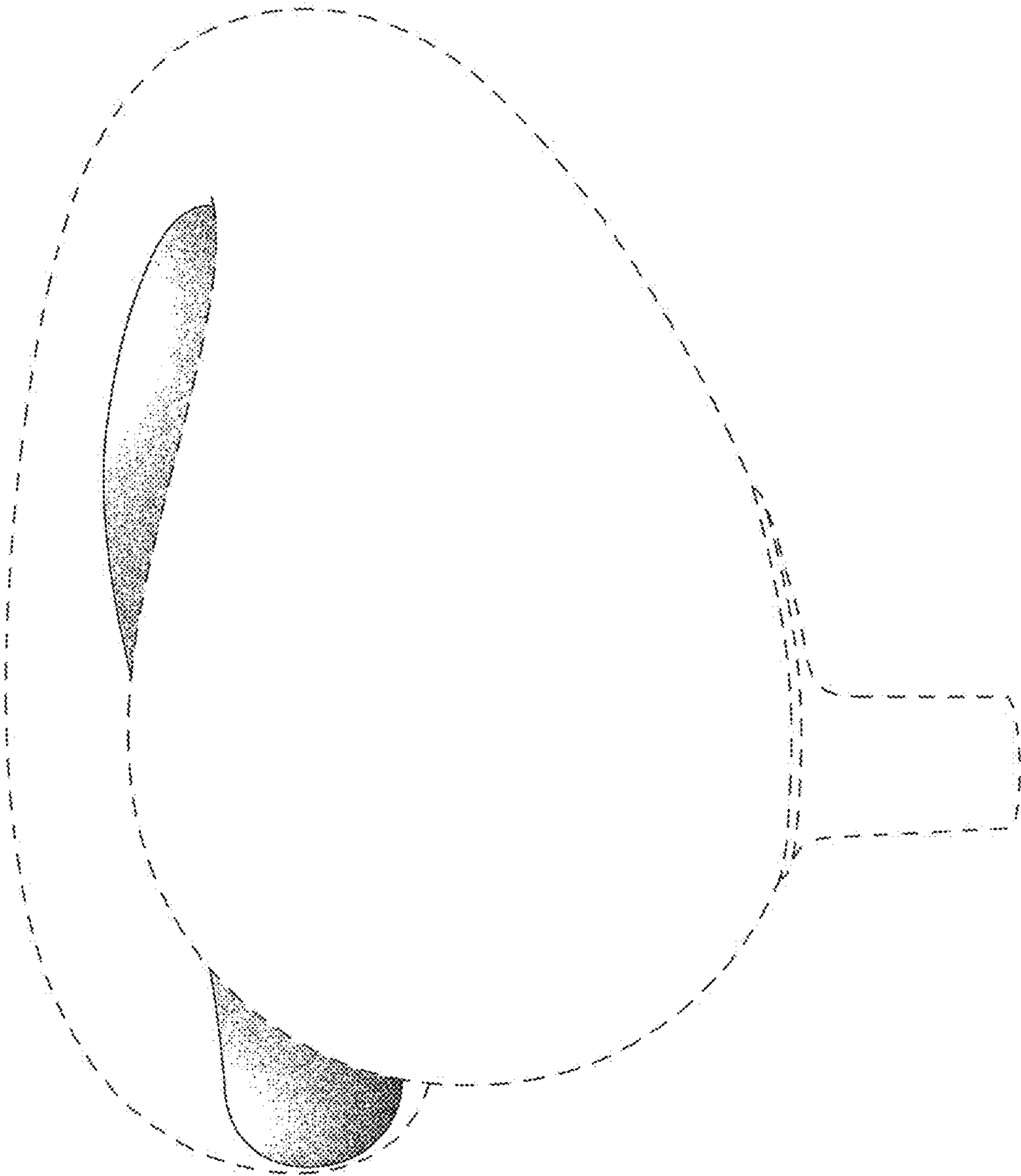


FIG. 11

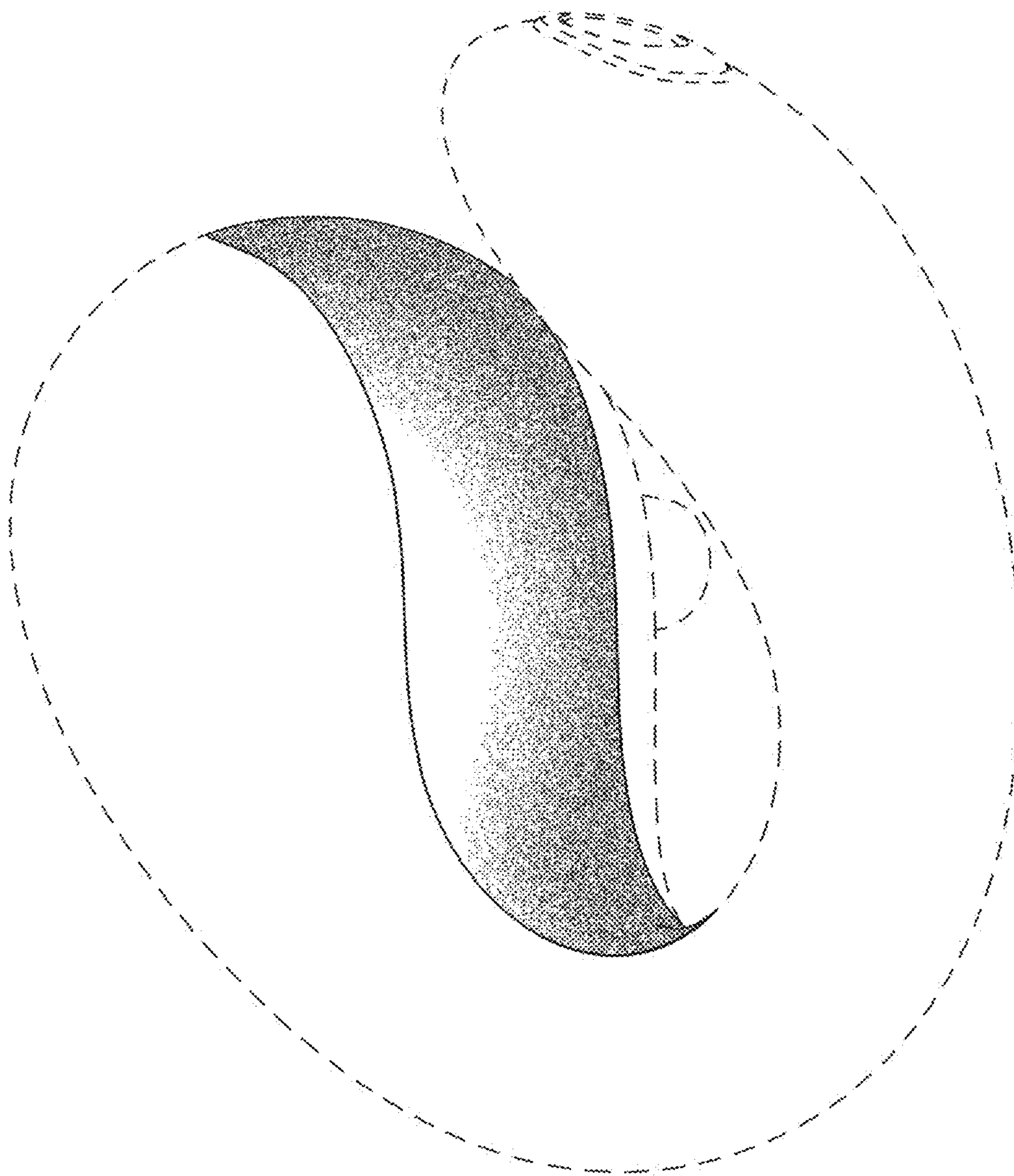


FIG. 12

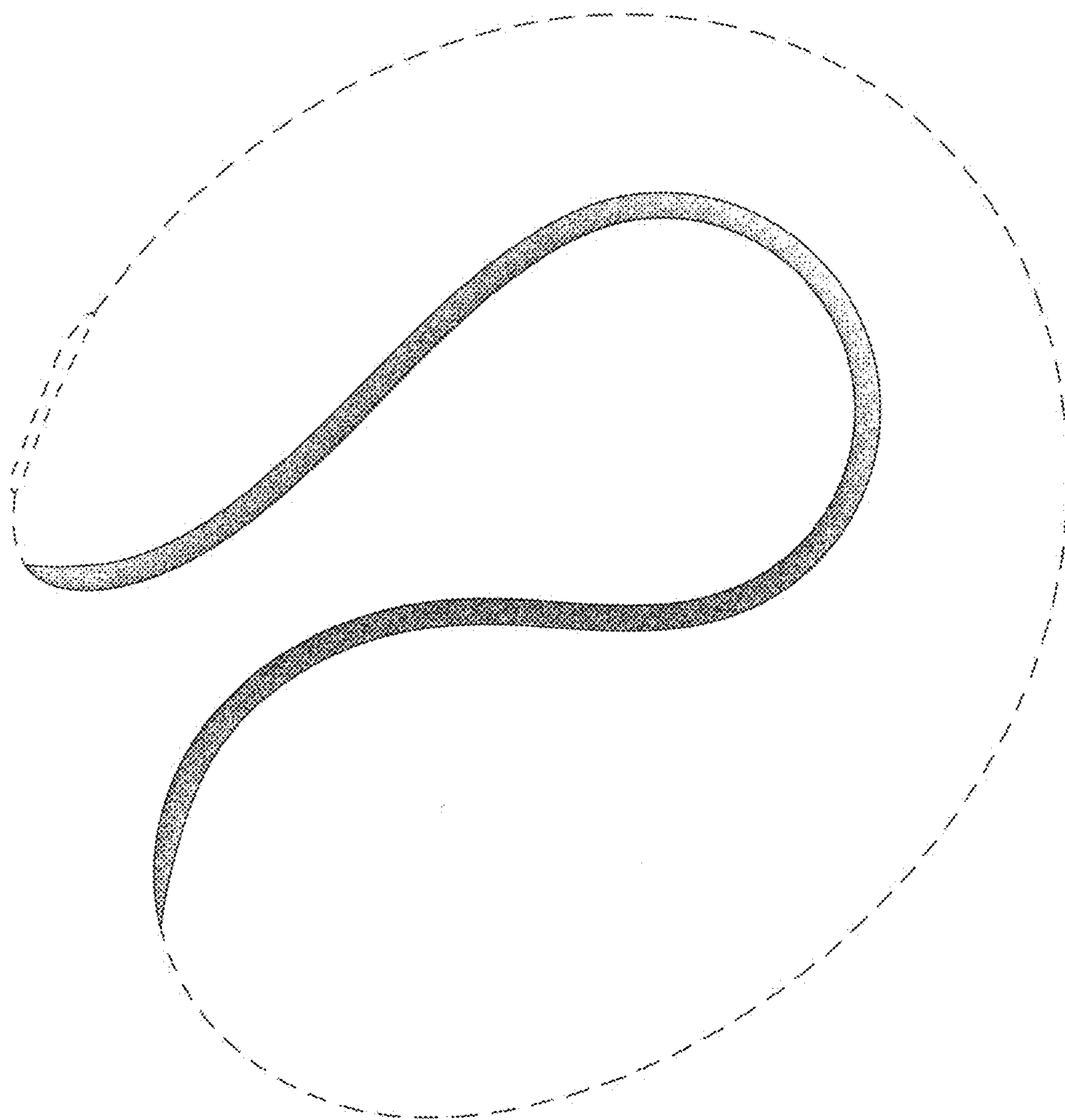


FIG. 13

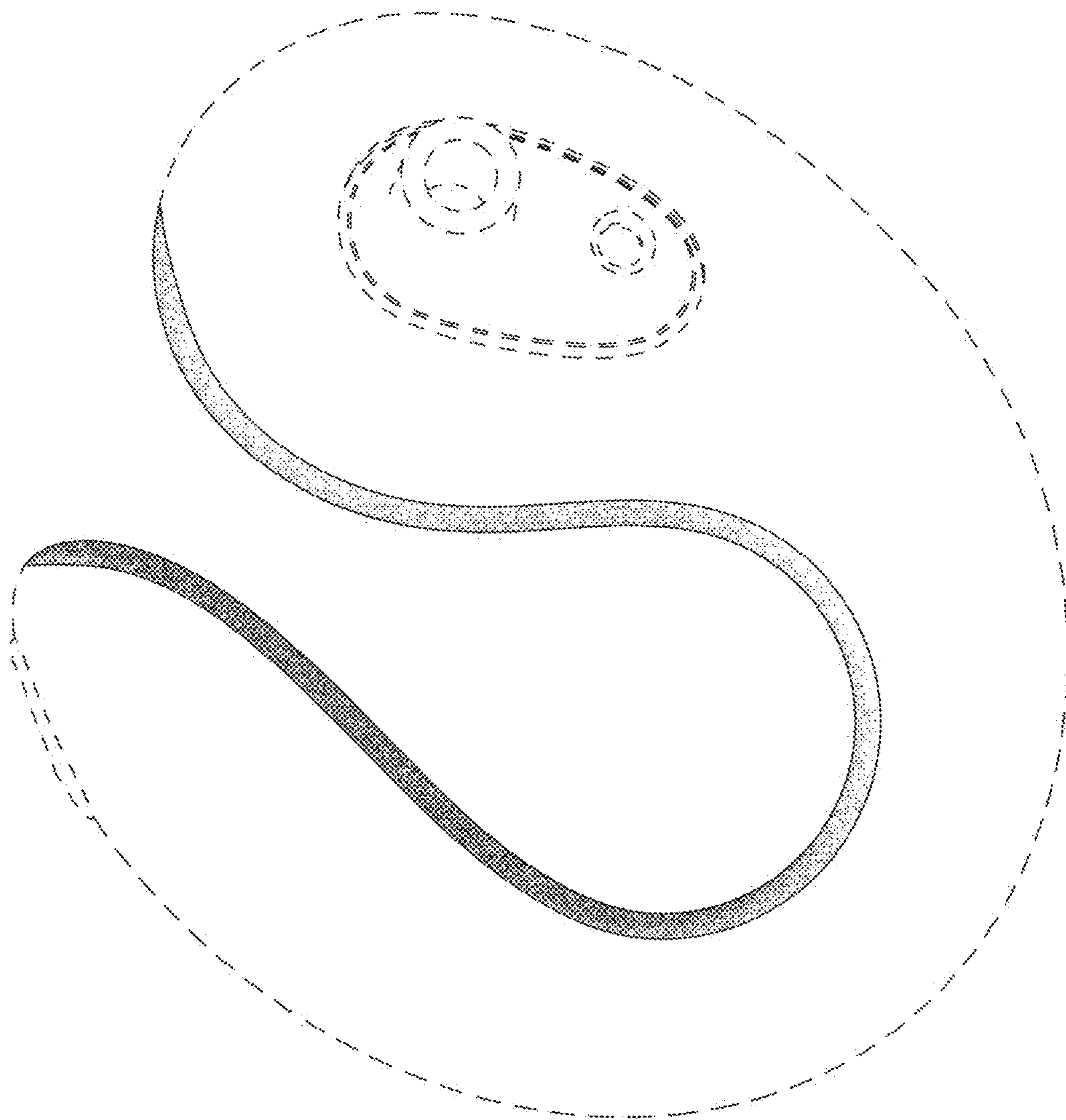


FIG. 14

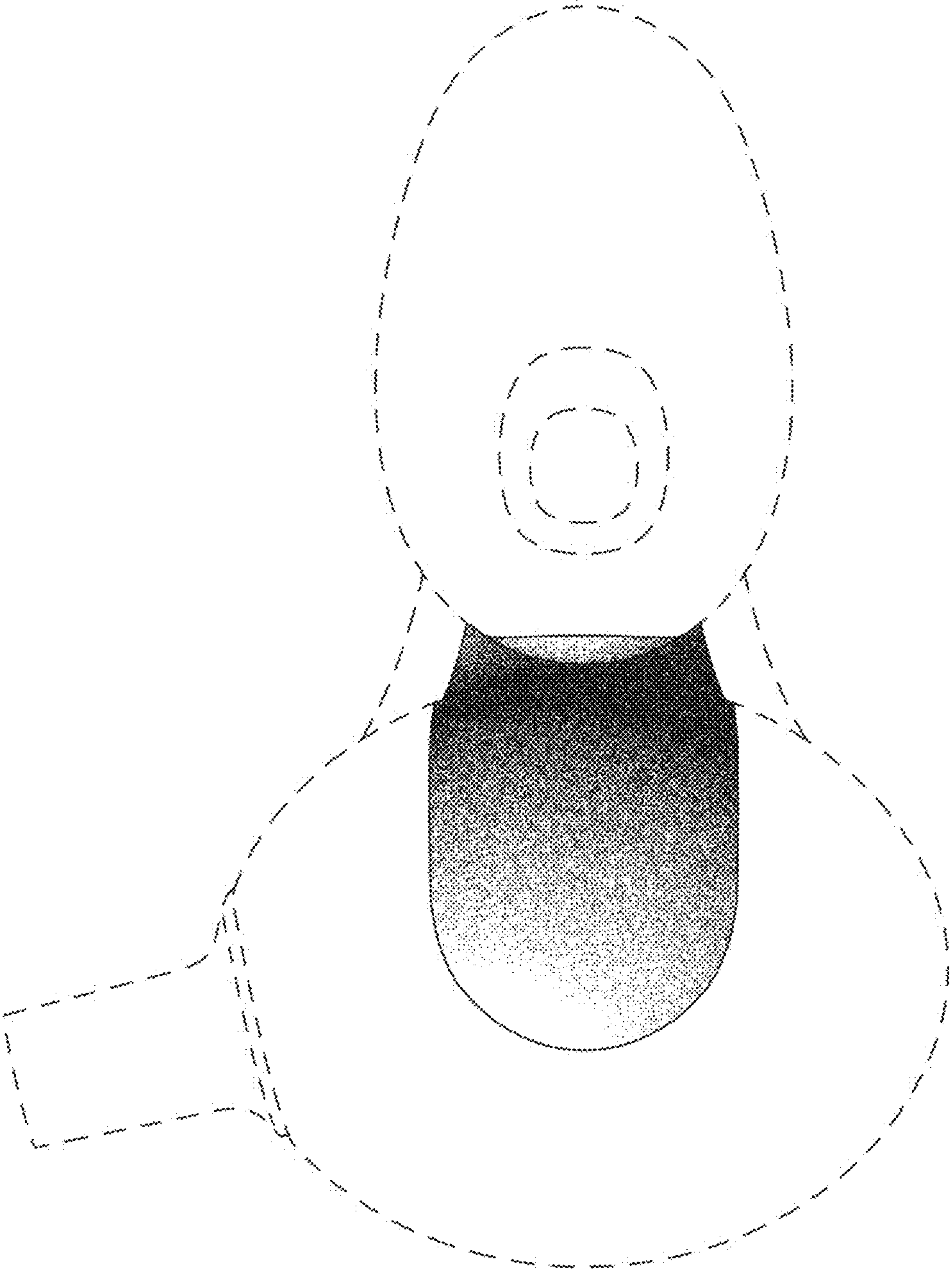


FIG. 15

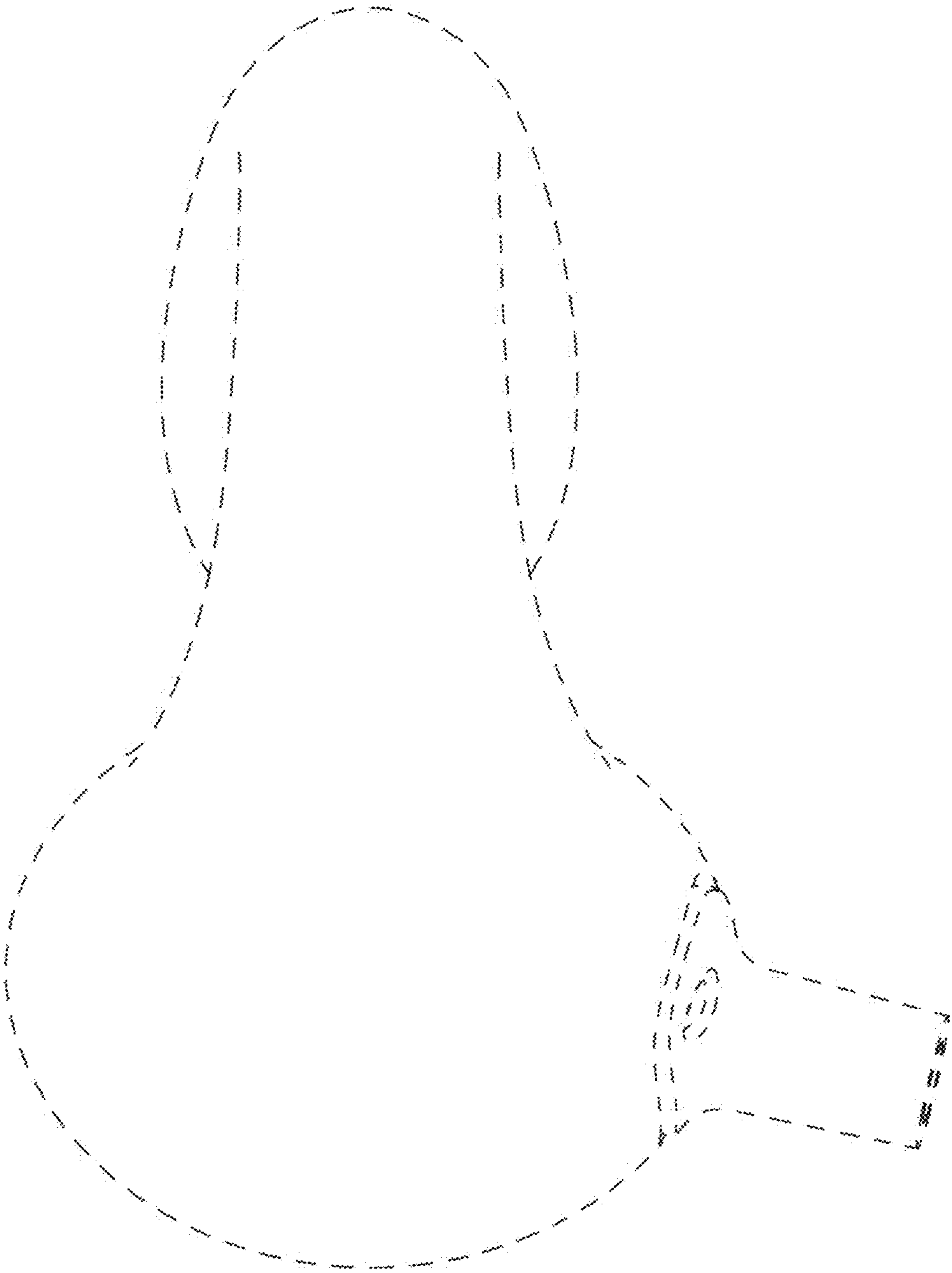


FIG. 16

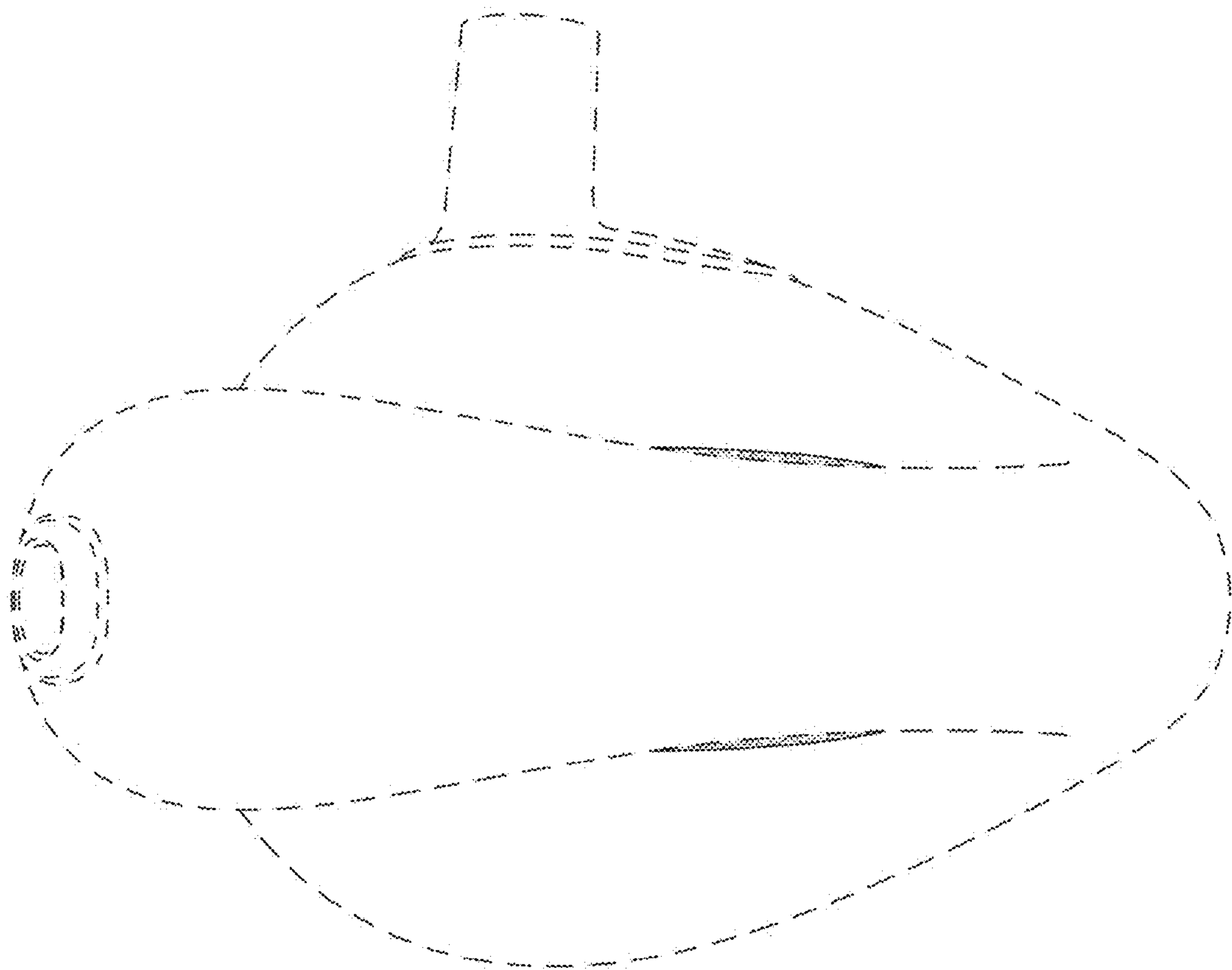


FIG. 17

